

### **Low VF Schottky Diode Array**

• Reverse voltage: 30 V

• Forward current: 0.9 A

 Small diode quad array for polarity independence, reverse polarity protection and low loss bridge rectification

Very low forward voltage:0.5 V typ. @ 0.7 A (per diode)

- Fast switching
- Pb-free (ROHS compliant) package<sup>1)</sup>
- Qualified according AEC Q101





### BAS3007A-RPP

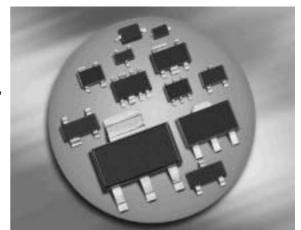


Туре	Package	Configuration	Marking
BAS3007A-RPP	SOT143	bridge	E1s

# **Maximum Ratings** at $T_A = 25$ °C, unless otherwise specified

Parameter	Symbol	Value	Unit
Diode reverse voltage <sup>2)</sup>	$V_{R}$	30	V
Peak reverse voltage <sup>2)</sup>	$V_{\rm RM}$	30	
RMS reverse voltage <sup>2)</sup>	V <sub>R(RMS)</sub>	21	
Forward current <sup>2)</sup>	I <sub>F</sub>		mA
<i>T</i> <sub>S</sub> ≤ 46°C		900	
<i>T</i> <sub>S</sub> ≤ 82°C		700	
Non-repetitive peak surge forward current	I <sub>FSM</sub>	5	А
( <i>t</i> ≤ 10 ms)			
Junction temperature	$T_{i}$	150	°C
Storage temperature	T <sub>stg</sub>	-65 150	

<sup>&</sup>lt;sup>1</sup>Pb-containing package may be available upon special request



 $<sup>^2</sup>$ For  $T_A > 25$ °C the derating of  $V_R$  and  $I_F$  has to be considered. Please refer to the attached curves.



**Thermal Resistance** 

Parameter	Symbol	Value	Unit
Junction - soldering point <sup>1)</sup>	R <sub>thJS</sub>	≤ 95	K/W

**Electrical Characteristics** at  $T_{\Delta}$  = 25°C, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
DC Characteristics					
Reverse current (per diode) <sup>2)</sup>	I <sub>R</sub>				μΑ
<i>V</i> <sub>R</sub> = 12 V		-	-	30	
<i>V</i> <sub>R</sub> = 30 V		-	-	350	
Forward voltage (per diode) <sup>2)3)</sup>	$V_{F}$				٧
$I_{\rm F}$ = 100 mA		-	0.35	0.4	
/ <sub>F</sub> = 350 mA		-	0.4	0.5	
$I_{\rm F}$ = 500 mA		-	0.45	0.55	
/ <sub>F</sub> = 700 mA		-	0.5	0.6	
<i>I</i> <sub>F</sub> = 900 mA		-	0.6	0.7	
AC Characteristics					
Diode capacitance (per diode)	C <sub>T</sub>	-	9	15	pF
$V_{R} = 5 \text{ V}, f = 1 \text{ MHz}$					

 $<sup>^{1}</sup>$ For calculation of  $R_{\mathrm{thJA}}$  please refer to Application Note Thermal Resistance

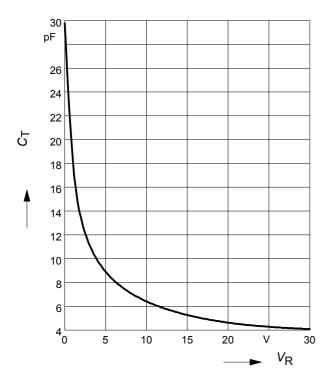
<sup>&</sup>lt;sup>2</sup>Pulsed test,  $t_{\rm D}$  = 300 µs; D = 0.01

<sup>&</sup>lt;sup>3</sup>When used as shown for Reverse Polarity Protection (RPP, see page 4), the voltage available to the circuit being protected will be two diode drops below the power supply voltage. In other words, the supply current will pass through two diodes.



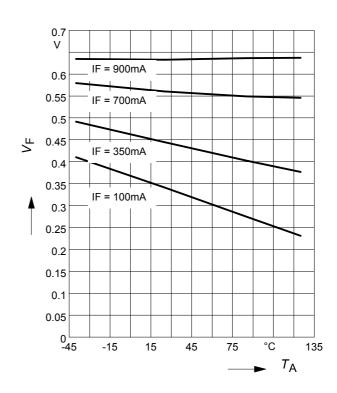
## **Diode capacitance** $C_T = f(V_R)$

f = 1MHz (per diode)



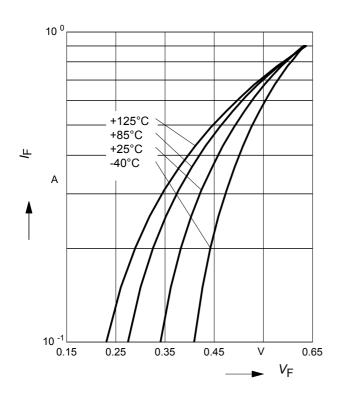
# Forward Voltage $V_F = f(T_A)$

 $I_{F}$  = Parameter (per diode)



# Forward current $I_F = f(V_F)$

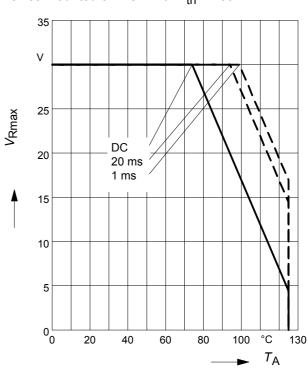
 $T_A$  = Parameter (per diode)



# Permissible Reverse voltage $V_R = f(T_A)$

 $t_p$  = Paramter, Duty cycle < 0.01

Device mounted on PCB with  $R_{th}$  = 160 K/W

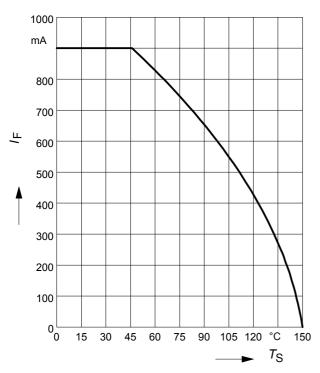




### Forward current $I_F = f(T_S)$

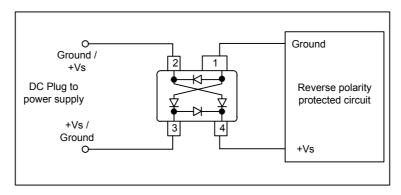
Current flows through two chips

per package at the same time (per array)



### Application example BAS3007A-RPP

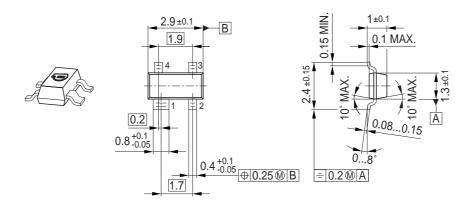
Advanced Reverse Polarity Protection(RPP): due to diode orientation, circuit at the right will be protected from damage and will also function normally in the event reverse polarity is applied to pins 2 and 3 of the BAS3007A-RPP.



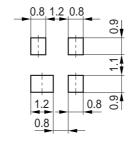
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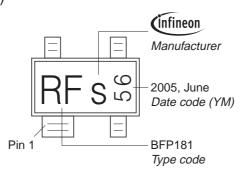
## Package Outline



### Foot Print

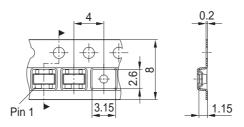


## Marking Layout (Example)



# Standard Packing

Reel ø180 mm = 3.000 Pieces/Reel Reel ø330 mm = 10.000 Pieces/Reel



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